imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

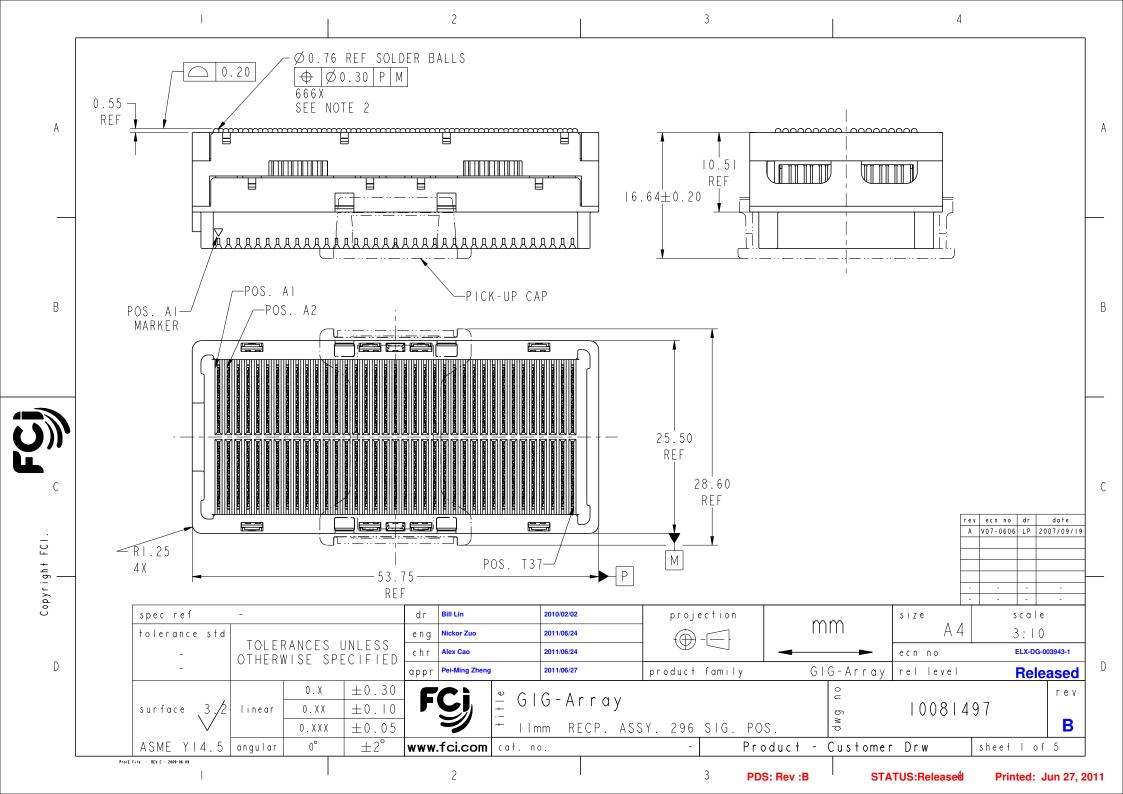
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

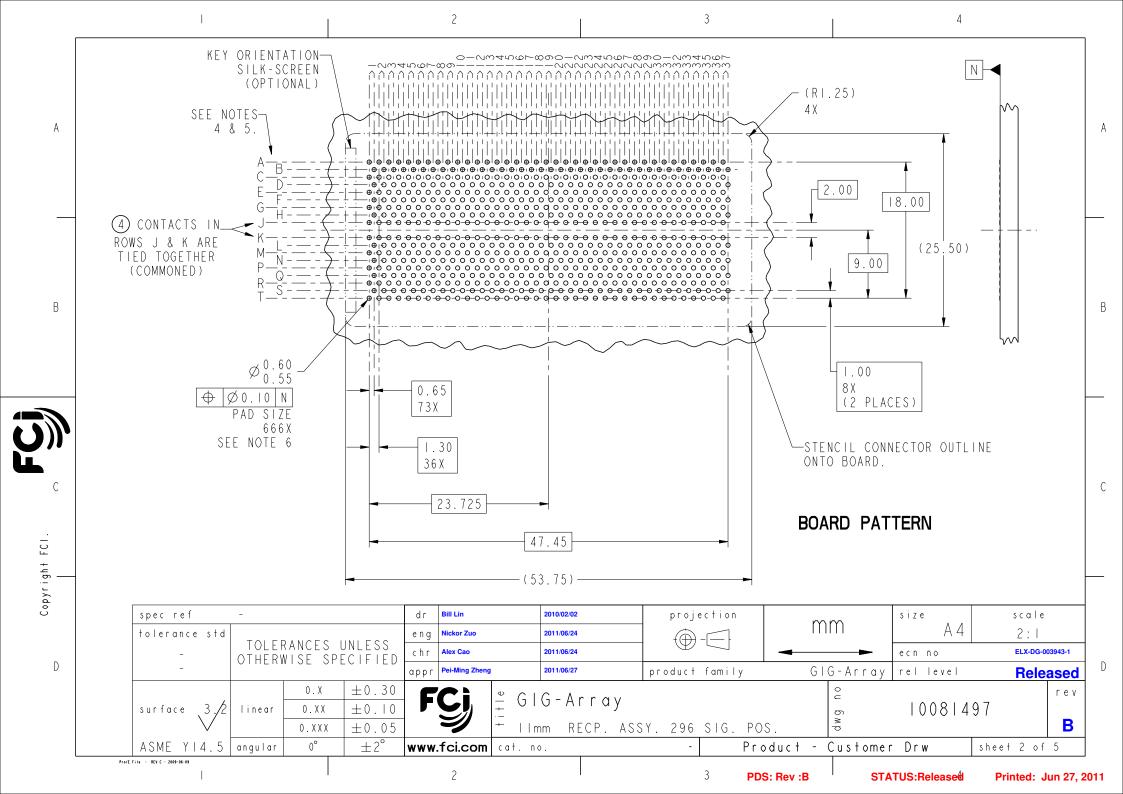


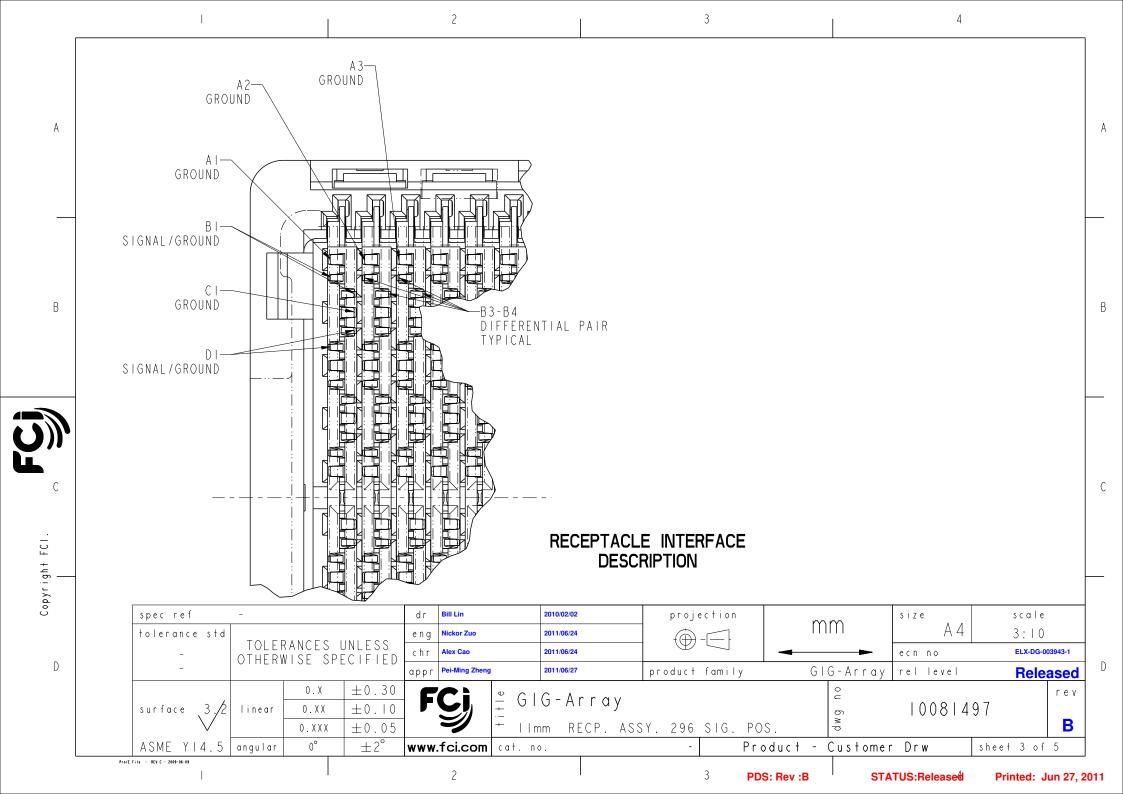
Contact us

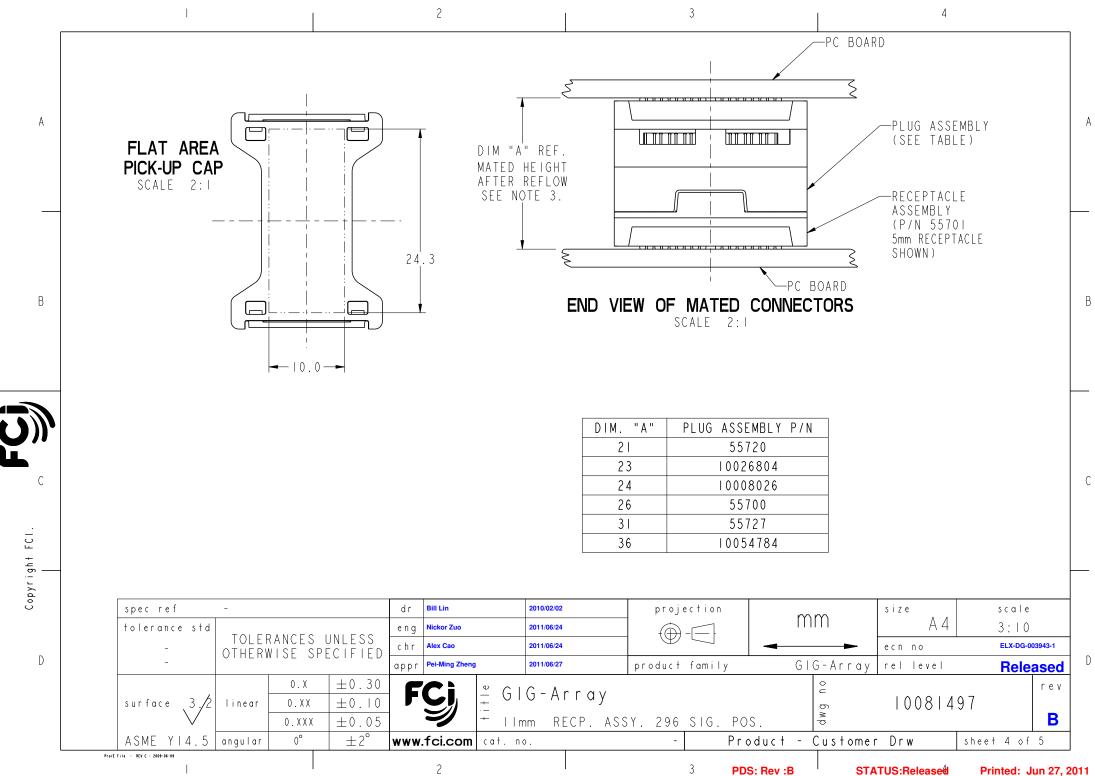
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











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-	PRODUCT NUMBER	SOLDER BAL					NG PERFORMANC				
-	10081497-001		(EUTECTI)	TH	HE REQUIF	EMENTS OF	FCI PRODUCT	FIED TO MEET SPECIFICATION			
-	10081497-001LF	LEA	DFREE	GS	8-12-192,	INCLUDING	TELCORDIA CE	ENTRAL OFFICE			
А											
	N	OTES:									
		MATERIAL:									
		CONTAC	T: COPPER								
			G (CONTACT ING: 94 V		ER Ni.			CONTINUED			
		SOLDER	BALL: (SE	E TABLE)			\bigcirc	CIFIED POSITION, ATION WITHIN LAN			
		SnPb Ol	R LEADFREE	95.5 Sn	/4Ag/0.5	Cu	OF	LAND PATTERN TO	FUDICIAL MARKS	OR PCB DATUMS	
В	(2) SOLDER BALLS WILL NOT BE PERFECT							LL BE DEFINED BY DUCT APPLICATION			
D	SHPERICAL SHAPE DUE TO REFLOW ATTACHMENT.						DOC	. NO. GS-20-016.			
	(MATED HEI	GHT FFFFC	TED BY CL	ISTOMERS '		<u> </u>	PROPER APPLICAT			
	(3) MATED HEIGHT EFFECTED BY CUSTOMERS' PCB PAD SIZE, PLATING, SOLDER REFLOW							IFICATION GS-20- NOT SOLDER PROF			
		PROFILE &						ESS DUE TO A HIG			
	(4) CONTACTS IN ROWS A,C,E,G,J,K,M,P,R AND T										
	ARE SINGLE BEAM CONTACTS, SPECIFICATION.										
		TYPICALLY (NOTE: COI					~	S PRODUCT MEETS '	THE EUROPEAN UNI	ON	
C			ED TOGETHE				DIRE	CTIVES AND OTHER	R COUNTRY REGULA	TIONS AS DESC	
C						C		S-22-008. PRODUC TIFIED IN THE LC			
		5) CONTACTS ARE DUAL I			N,Q AND	2	PART	BY HAVING AN "X	" IN THE SEVENT	H CHARACTER P	POSITION.
FCI.		TYPICALLY			NS.						
Copyright											
ပိ	specref -				d r Bill Lin	20	0/02/02	projection	mm	size	scale
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D		OTHERWISE SPECIFIE) chr Alex Cao appr Pei-Ming Zheng		/06/24 /06/27 pr	product family	GIG-Array	ecn no rel level	ELX-DG-003943-1
			0.X	±0.30							Released
	surface	3.2 linear		±0.10	FCi	GIG	-Array		с Б	1008149	
		\vee		±0.05	Ų		RECP. ASS	Y. 296 SIG. PO			B
	ASME YI	4.5 angular	0°	$\pm 2^{\circ}$ w	ww.fci.co	m cat. no.		- Pro	duct - Custome	r Drw	sheet 5 of 5